

What is Claimed is:

1. A solvent-free moisture-curable hot melt urethane resin composition comprising an isocyanate group-containing hot melt urethane prepolymer (A), a morpholine ether-based crosslinking catalyst (B), and at least one sulfur atom-containing organic acid (C) selected from the group consisting of sulfonic acids and sulfinic acids as essential components.
2. The solvent-free moisture-curable hot melt urethane resin composition according to claim 1, wherein the isocyanate group-containing hot melt urethane prepolymer (A) is a urethane prepolymer having an isocyanate group originated from diphenylmethane diisocyanates at a molecular end.
3. The solvent-free moisture-curable hot melt urethane resin composition according to claim 1, wherein the morpholine ether-based crosslinking catalyst (B) comprises 2,2'-dimorpholino diethyl ether and/or di(2,6-dimethylmorpholinoethyl)ether.
4. The solvent-free moisture-curable hot melt urethane resin composition according to claim 1, wherein the sulfur atom-containing organic acid (C) comprises methanesulfonic acid and/or ethanesulfonic acid.